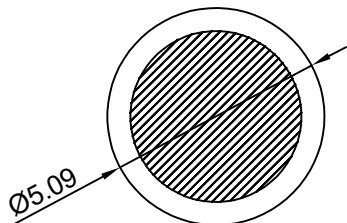


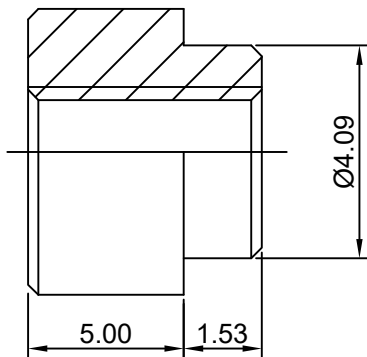
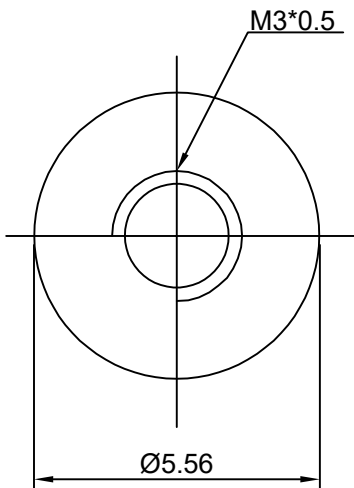
RoHS

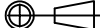
REV.	ECN NO.	DESCRIPTION	DESIGN	APPROVAL	DATE
A1	NEW	更换图框			2023.09.03



PCB LAYOUT

- 技术要求:
- 1.打铜底0.5-1μm,镍2-2.5μm, 镀亮锡3-5μm。
 - 2.铆好后不得有松动现象。
 - 3.插脚尖部符合可焊性要求。
 - 4.螺纹需符合通止规/止针要求。
 - 5.螺纹扭矩: 0.5Nm.



> 30.±0.4 6-30±0.3 0-6±0.2 ANGLES±1° UNITS:	X.°± .X°± .XX°± .XXX°± mm	PART NO: TS30556-0653 TITLE: PCB SOLDERING TERMINAL	XFCN 兴飞连接器 0769-82001899 www.xfconn.com DWG NO: /				
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF XFCN AND SHALL NOT BE REPRODUCED.COPIED OR CUED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF XFCN		APPD	Chen ZhiQiang		VIEW 		
		CHKD	Liu Wei				
		DRAW	Chen HongJiang		SCALE	SHEET	REV
		DATE	2024.08.22		NONE	1/1	A1

1	插脚		C3604	1
序号	名称	零件编号	材质	数量